

## PRELIMINARY DATA

### QUAD 2-INPUT NAND SCHMITT TRIGGERS

- SCHMITT-TRIGGER ACTION ON EACH INPUT WITH NO EXTERNAL COMPONENTS
- HYSTERESIS VOLTAGE TYPICALLY 0.9V AT  $V_{DD} = 5V$  AND 2.3V AT  $V_{DD} = 10V$
- NOISE IMMUNITY GREATER THAN 50% OF  $V_{DD}$  (TYP.)
- NO LIMIT ON INPUT RISE AND FALL TIMES
- STANDARDIZED SYMMETRICAL OUTPUT CHARACTERISTICS
- QUIESCENT CURRENT SPECIFIED TO 20V
- MAXIMUM INPUT CURRENT OF 1  $\mu A$  AT 18V (FULL PACKAGE-TEMPERATURE RANGE)
- 5V, 10V, AND 15V PARAMETRIC RATINGS

The **HCC 4093B** (extended temperature range) and **HCF 4093B** (intermediate temperature range) are available in 14-lead dual in-line plastic or ceramic package, and ceramic flat package.

The **HCC/HCF 4093B** consists of four Schmitt-trigger circuits. Each circuit functions as a two-input NAND gate with Schmitt-trigger action on both inputs. The gate switches at different points for positive and negative-going signals.

The difference between the positive voltage ( $V_P$ ) and the negative voltage ( $V_N$ ) is defined as hysteresis voltage ( $V_H$ ) (See Fig. 1).

### ABSOLUTE MAXIMUM RATINGS

$V_{DD}^*$	Supply voltage	-0.5 to 20	V
$V_I$	Input voltage	-0.5 to $V_{DD} + 0.5$	V
$I_I$	DC input current (any one input)	$\pm 10$	mA
$P_{tot}$	Total power dissipation (per package)	200	mW
	Dissipation per output transistor		
	for $T_{op}$ = full package-temperature range	100	mW
$T_{op}$	Operating temperature: for <b>HCC</b> types	-55 to 125	$^{\circ}C$
	for <b>HCF</b> types	-40 to 85	$^{\circ}C$
$T_{stg}$	Storage temperature	-65 to 150	$^{\circ}C$

\* All voltage values are referred to  $V_{SS}$  pin voltage

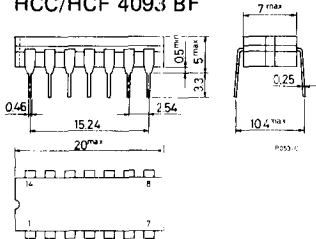
### ORDERING NUMBERS:

- HCC 4093 BD for dual in-line ceramic package
- HCC 4093 BF for dual in-line ceramic package, frit seal
- HCC 4093 BK for ceramic flat package
- HCF 4093 BE for dual in-line plastic package
- HCF 4093 BF for dual in-line ceramic package, frit seal

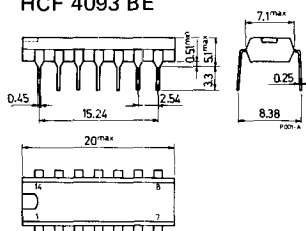
# HCC/HCF 4093 B

## MECHANICAL DATA (dimensions in mm)

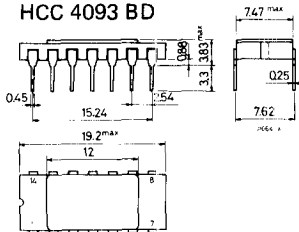
Dual in-line ceramic package for HCC/HCF 4093 BF



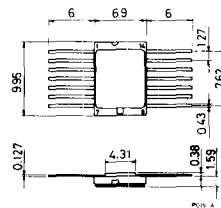
Dual in-line plastic package for HCF 4093 BE



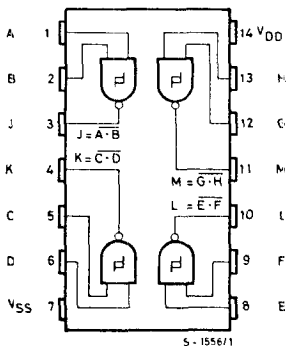
Dual in-line ceramic package for HCC 4093 BD



Ceramic flat package for HCC 4093 BK

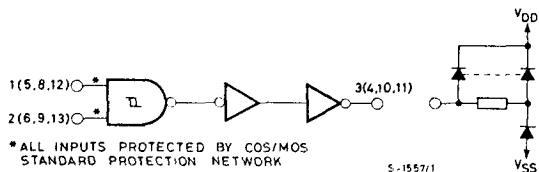


## CONNECTION DIAGRAM



## FUNCTIONAL DIAGRAM

1 of 4 Schmitt triggers



## RECOMMENDED OPERATING CONDITIONS

$V_{DD}$	Supply voltage	3 to 18	V
$V_I$	Input voltage	0 to $V_{DD}$	V
$T_{op}$	Operating temperature: for HCC types for HCF types	-55 to 125 -40 to 85	°C °C



**STATIC ELECTRICAL CHARACTERISTICS** (over recommended operating conditions)

Parameter	Test conditions				Values						Unit	
	V <sub>I</sub> (V)	V <sub>O</sub> (V)	I <sub>OL</sub>   ( $\mu$ A)	V <sub>DD</sub> (V)	T <sub>Low</sub> *		25°C			T <sub>High</sub> *		
					Min.	Max.	Min.	Typ.	Max.	Min.		Max.
I <sub>L</sub> Quiescent supply current	0/ 5			5		1		0.02	1		30	$\mu$ A
	0/10			10		2		0.02	2		60	
	0/15			15		4		0.02	4		120	
	0/20			20		20		0.04	20		600	
V <sub>P</sub> Positive trigger threshold voltage	a			5	2.2	3.6	2.2	2.9	3.6	2.2	3.6	V
	a			10	4.6	7.1	4.6	5.9	7.1	4.6	7.1	
	a			15	6.8	10.8	6.8	8.8	10.8	6.8	10.8	
	b			5	2.6	4	2.6	3.3	4	2.6	4	
	b			10	5.6	8.2	5.6	7	8.2	5.6	8.2	
	b			15	6.3	12.7	6.3	9.4	12.7	6.3	12.7	
V <sub>N</sub> Negative trigger threshold voltage	a			5	0.9	2.8	0.9	1.9	2.8	0.9	2.8	V
	a			10	2.5	5.2	2.5	3.9	5.2	2.5	5.2	
	a			15	4	7.4	4	5.8	7.4	4	7.4	
	b			5	1.4	3.2	1.4	2.3	3.2	1.4	3.2	
	b			10	3.4	6.6	3.4	5.1	6.6	3.4	6.6	
	b			15	4.8	9.6	4.8	7.3	9.6	4.8	9.6	
V <sub>H</sub> Hysteresis voltage	a			5	0.3	1.6	0.3	0.9	1.6	0.3	1.6	V
	a			10	1.2	3.4	1.2	2.3	3.4	1.2	3.4	
	a			15	1.6	5	1.6	3.5	5	1.6	5	
	b			5	0.3	1.6	0.3	0.9	1.6	0.3	1.6	
	b			10	1.2	3.4	1.2	2.3	3.4	1.2	3.4	
	b			15	1.6	5	1.6	3.5	5	1.6	5	
V <sub>OH</sub> Output high voltage	0/ 5		< 1	5	4.95		4.95			4.95		V
	0/10		< 1	10	9.95		9.95			9.95		
	0/15		< 1	15	14.95		14.95			14.95		
V <sub>OL</sub> Output low voltage	5/0		< 1	5		0.05			0.05		0.05	V
	10/0		< 1	10		0.05			0.05		0.05	
	15/0		< 1	15		0.05			0.05		0.05	
I <sub>OH</sub> Output drive current	HCC types	0/ 5	2.5		5	-2		-1.6	-3.2		-1.15	mA
		0/ 5	4.6		5	-0.64		-0.51	-1		-0.36	
		0/10	9.5		10	-1.6		-1.3	-2.6		-0.9	
		0/15	13.5		15	-4.2		-3.4	-6.8		-2.4	
	HCF types	0/ 5	2.5		5	-1.8		-1.6	-3.2		-1.3	
		0/ 5	4.6		5	-0.61		-0.51	-1		-0.42	
		0/10	9.5		10	-1.5		-1.3	-2.6		-1.1	
		0/15	13.5		15	-4		-3.4	-6.8		-2.8	

a : input on terminals 1, 5, 8, 12 or 2, 6, 9, 13; other inputs to V<sub>DD</sub>.  
b : input on terminals 1 and 2, 5 and 6, 8 and 9, or 12 and 13; other inputs to V<sub>DD</sub>.

## STATIC ELECTRICAL CHARACTERISTICS (continued)

Parameter		Test conditions				Values						Unit	
		V <sub>I</sub> (V)	V <sub>O</sub> (V)	I <sub>O</sub>   (μA)	V <sub>DD</sub> (V)	T <sub>Low</sub> *		25°C			T <sub>High</sub> *		
						Min.	Max.	Min.	Typ.	Max.	Min.		Max.
I <sub>OL</sub> Output sink current	HCC types	0/ 5	0.4		5	0.64		0.51	1		0.36		mA
		0/10	0.5		10	1.6		1.3	2.6		0.9		
		0/15	1.5		15	4.2		3.4	6.8		2.4		
	HCF types	0/ 5	0.4		5	0.61		0.51	1		0.42		
		0/10	0.5		10	1.5		1.3	2.6		1.1		
		0/15	1.5		15	4		3.4	6.8		2.8		
I <sub>IH</sub> , I <sub>IL</sub> Input leakage current		0/18	Any input		18		± 0.1		± 10 <sup>-5</sup>	± 0.1		± 1	μA
C <sub>I</sub> Input capacitance			Any input						5	7.5			pF

\* T<sub>Low</sub> = - 55°C for HCC device; - 40°C for HCF device.

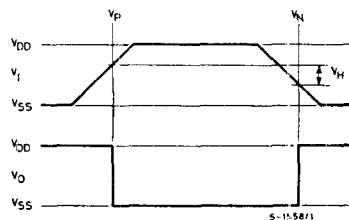
\* T<sub>High</sub> = +125°C for HCC device; + 85°C for HCF device.

## DYNAMIC ELECTRICAL CHARACTERISTICS (T<sub>amb</sub> = 25°C, C<sub>L</sub> = 50 pF, R<sub>L</sub> = 200 kΩ, typical temperature coefficient for all V<sub>DD</sub> values is 0.3%/°C, all input rise and fall times = 20 ns)

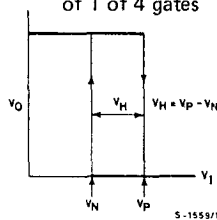
Parameter	Test conditions	Values			Unit	
		V <sub>DD</sub> (V)	Min.	Typ.		Max.
t <sub>PLH</sub> , t <sub>PHL</sub> Propagation delay time		5		300	600	ns
		10		150	300	
		15		120	240	
t <sub>TLH</sub> , t <sub>THL</sub> Transition time		5		100	200	ns
		10		50	100	
		15		40	80	

Fig. 1 - Hysteresis definition, characteristic and test setup

(a) Definition of V<sub>P</sub>, V<sub>N</sub> and V<sub>H</sub>



(b) Transfer characteristic of 1 of 4 gates



(c) Test setup

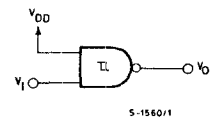


Fig. 2 - Input and output characteristics

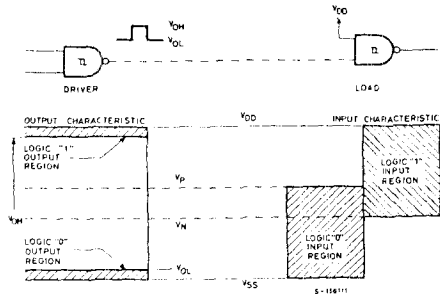


Fig. 3 - Typical current and voltage transfer characteristics

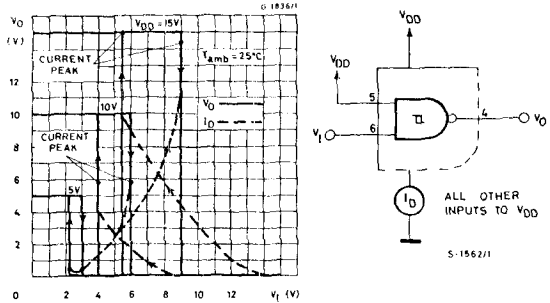


Fig. 4 - Typical voltage transfer characteristics as a function of temperature, and test circuit

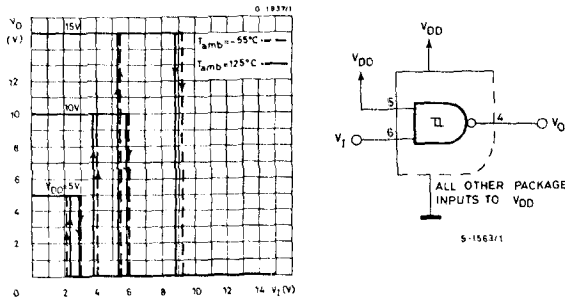


Fig. 5 - Typical output low (sink) current characteristics

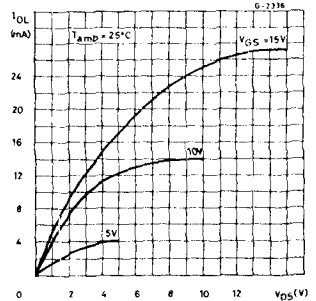


Fig. 6 - Minimum output low (sink) current characteristics

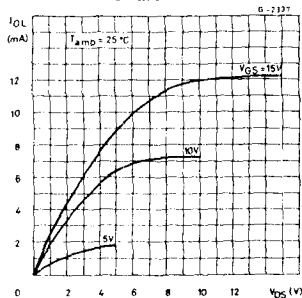


Fig. 7 - Typical output high (source) current characteristics

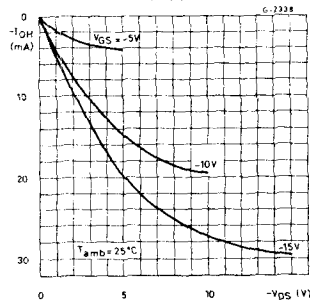
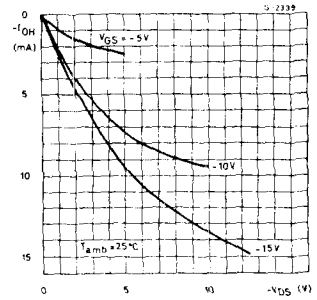
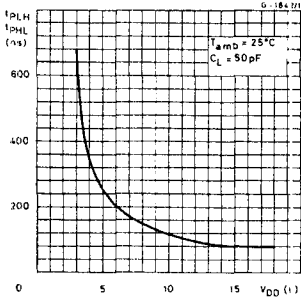


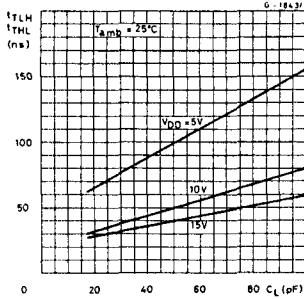
Fig. 8 - Minimum output high (source) current characteristics



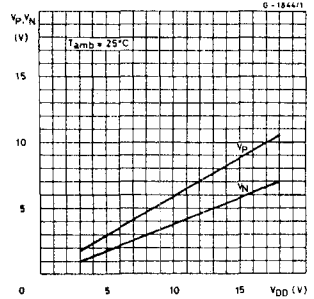
**Fig. 9 - Typical propagation delay time vs. supply voltage**



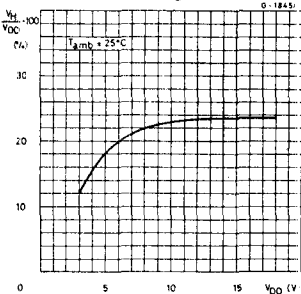
**Fig. 10 - Typical transition time vs. load capacitance**



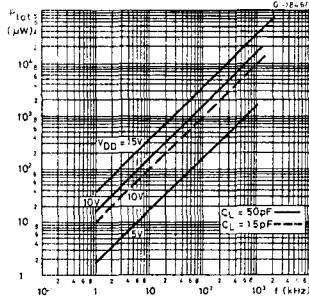
**Fig. 11 - Typical trigger threshold voltage vs. VDD**



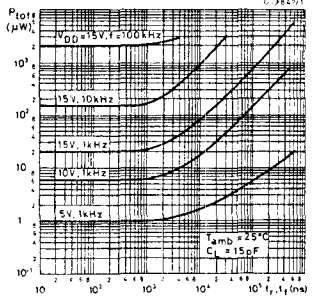
**Fig. 12 - Typical per cent hysteresis vs. supply voltage**



**Fig. 13 - Typical dissipation characteristics**

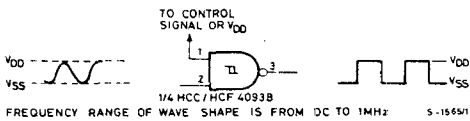


**Fig. 14 - Power dissipation vs. rise and fall times**

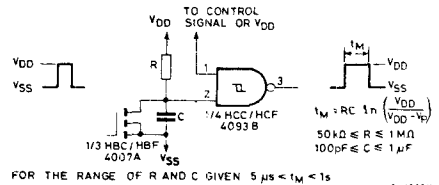


## APPLICATIONS

**Fig. 15 - Wave shaper**

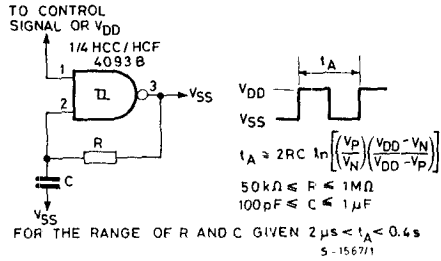


**Fig. 16 - Monostable multivibrator**



**APPLICATIONS (continued)**

Fig. 17 - Astable multivibrator



**TEST CIRCUITS**

Fig. 18 - Quiescent device current

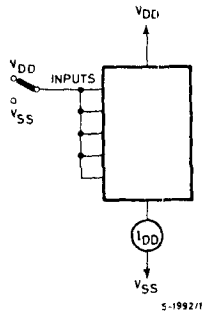


Fig. 19 - Input leakage current

